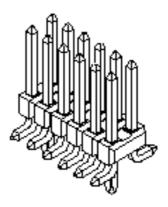


Part Number : 15916063

Product Description : 2.54mm Pitch C-Grid Breakaway Header, Surface Mount, Dual Row, Vertical, 6 Circuits, 0.76μm Gold (Au) Selective Plating, without PCB Locator Pegs, Tape and Reel

Series Number : 71308 Status : Active Product Category : PCB Headers and Receptacles Engineering Number : 71308-1706



Documents & Resources

Drawings

015916063_sd.pdf 713080000-PK-000.pdf 713080001-PK-000.pdf

3D Models and Design Files 015916063_stp.zip

Specifications 713080001-AS-000.pdf PS-71308-001.pdf

Product Environment Compliance

Compliance

GADSL/IMDS	Compliant with Exemption 44
China RoHS	®
EU ELV	Not Relevant
Low-Halogen Status	Not Low-Halogen per IEC 61249-2- 21
REACH SVHC	Not Contained per D(2024)6225-DC (07 Nov 2024)
EU RoHS	Compliant per EU 2015/863

Multiple Part Product Compliance Statements

- REACH SVHC
- Low-Halogen

Multiple Part Industry Compliance Documents

- IPC 1752A Class C
- IPC 1752A Class D
- Molex Product Compliance Declaration
- IEC-62474
- chemSHERPA (xml)

EU RoHS Certificate of Compliance

Part Details

General

Status	Active
Category	PCB Headers and Receptacles
Series	71308
Description	2.54mm Pitch C-Grid Breakaway Header, Surface Mount, Dual Row, Vertical, 6 Circuits, 0.76µm Gold (Au) Selective Plating, without PCB Locator Pegs, Tape and Reel
Application	Board-to-Board, Signal, Wire-to- Board
Component Type	PCB Header
Product Name	C-Grid
UPC	800754854443

Agency

CSA	LR19980
UL	E29179

Electrical

Current - Maximum per Contact	3.0A
Voltage - Maximum	250V

Physical

Breakaway	Yes
Circuits (Loaded)	6

Circuits (maximum)	6
Color - Resin	Black
Durability (mating cycles max)	50
Flammability	94V-0
Glow-Wire Capable	No
Lock to Mating Part	None
Material - Metal	Phosphor Bronze
Material - Plating Mating	Gold
Material - Plating Termination	Tin
Material - Resin	High Temperature Thermoplastic
Net Weight	0.364/g
Number of Rows	2
Orientation	Vertical
Packaging Type	Embossed Tape on Reel
PCB Locator	No
PCB Retention	None
Pitch - Mating Interface	2.54mm
Plating min - Mating	0.813µm
Plating min - Termination	2.032µm
Polarized to Mating Part	No
Polarized to PCB	No
Robotic Placement	Pick and Place Cap
Shrouded	No
Stackable	Yes
Temperature Range - Operating	-40° to +120°C
Termination Interface Style	Surface Mount

Solder Process Data

Max-Duration	5
Lead-Free Process Capability	REFLOW
Max-Cycle	1
Max-Temp	260

Mates with Part(s)

Description	Part Number
C-Grid Right-Angle, Dual Row, Surface Mount PCB Receptacles	<u>71979</u>
C-Grid Vertical, Dual Row, High Profile, Surface Mount PCB Connectors	<u>71395</u>
C-Grid Vertical, Dual Row, High Profile, Through Hole PCB Receptacles	<u>71850</u>
2.54mm Pitch C-Grid Shunt Terminal Housings	7859

This document was generated on Feb 28, 2025